

Conductive substrate BC module technology for new applications

Rosca, V. (Victor) | TNO Solar Energy

12th workshop on BC cell and module technology, Delft, 2024



TNO innovation
for life

Outline

- Introduction TNO Solar R&D program
- Outline BC module technology based on conductive back foil (CBF)
- New PV applications and PV integration
- Potential of the conductive substrate BC technology for IPV

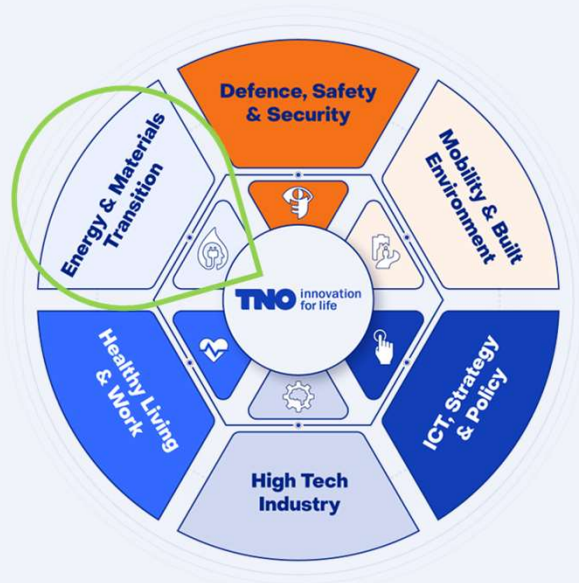
5-12-2024

Conductive substrate BC module technology for new applications

TNO Solar

TNO Energy & Materials Transition Unit

TNO develops technologies and concepts that drastically reduce the costs of generating **renewable electricity** thus accelerating the energy transition and promoting the circular economy



Rosca et al. 12th workshop on BC cell and module technology, Delft, 2024

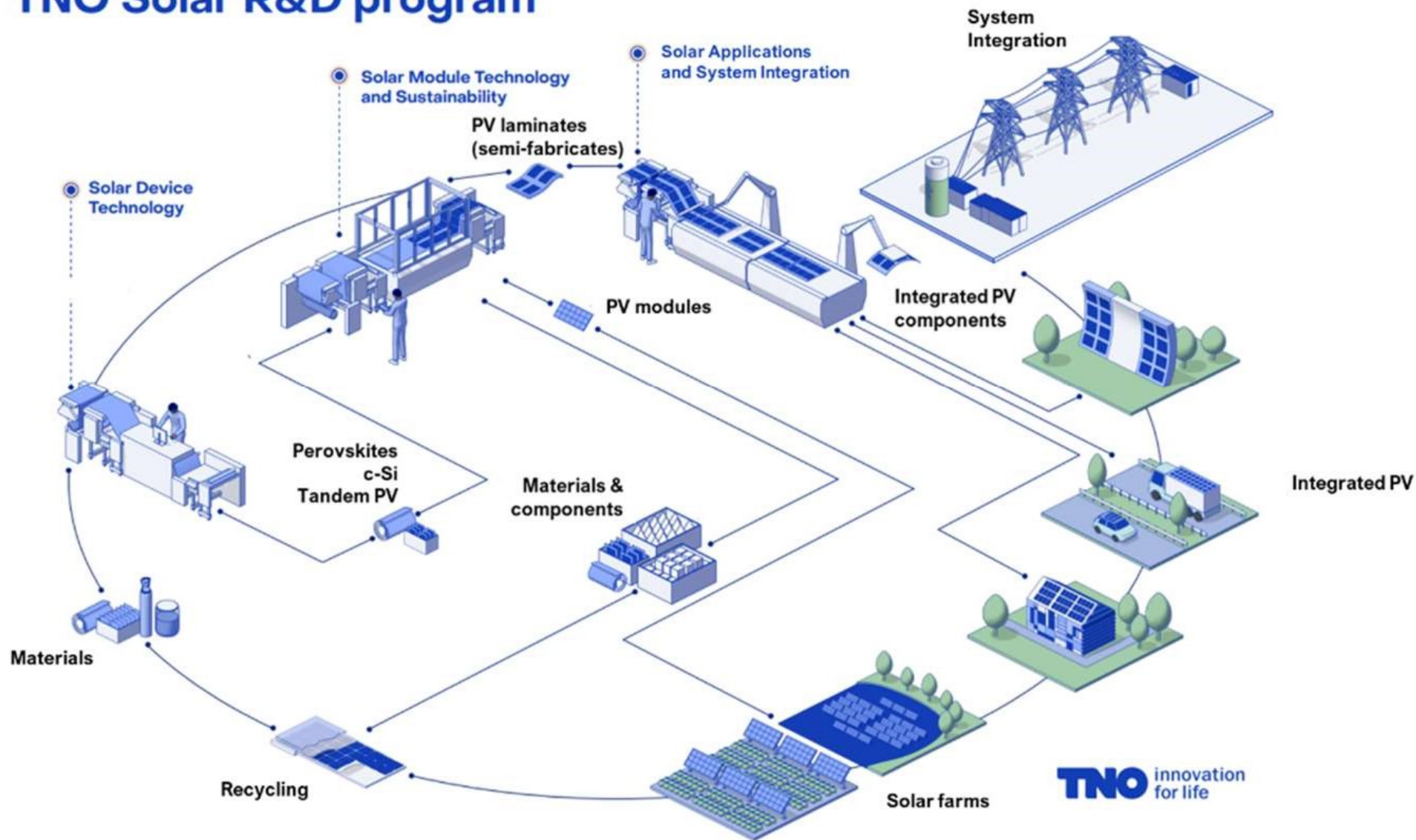
Main solar research locations



15 locations

3900 employees

TNO Solar R&D program



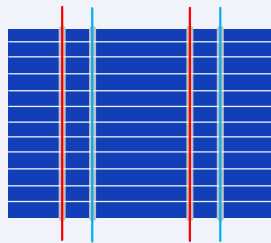
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Industrial BC interconnection technologies

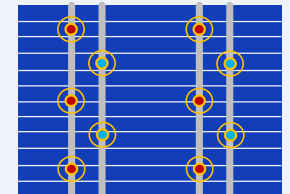
Back-contact module interconnection technologies

Tabbing stringing



- Module-level (ML) conductive grid: solder coated Cu ribbon or wires
- Continuous (linear) mechanical & electrical coupling between cell and ML grid
- Industrial method (more cost-efficient)
- Limited design flexibility

Conductive substrate

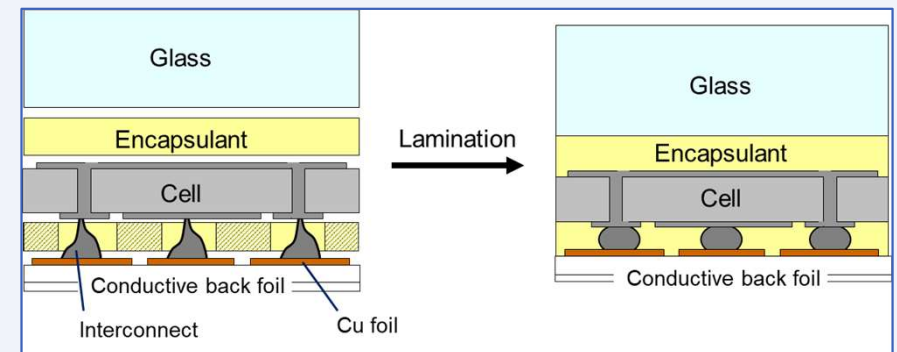
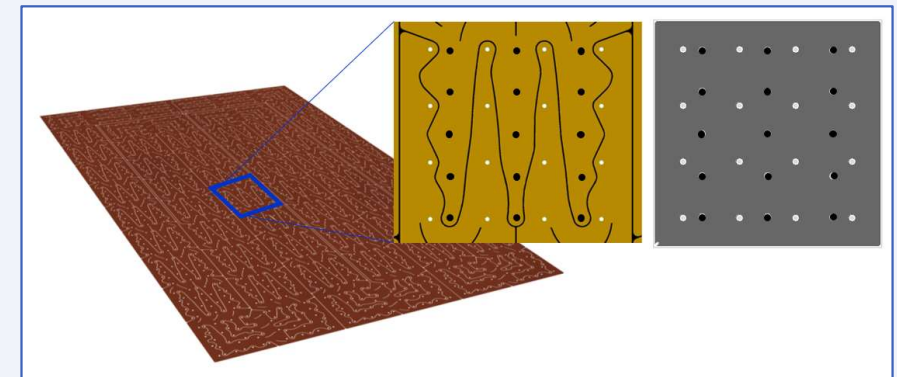


- Module-level (ML) conductive grid: PCB-like conductive substrate + interconnection material
- Discrete (contact dots) electrical coupling between cell and ML grid
- Industrial method
- High design flexibility

CBF BC module technology

Proven on the industrial scale module interconnection technology compatible with any BC cell (PERC-, HJT-) MWT, IBC

1. Higher cell and module efficiency
2. Higher production speed and yield
 - Suitable for larger and thinner wafers (handling of wafers down to 100um tested and validated)
 - Single-step interconnection and encapsulation
 - Higher level of automation
3. Low-T low-stress processing & interconnection (<150C)
4. Ultimate (electrical) design flexibility (PCB-like)
5. Improved esthetics



Outline

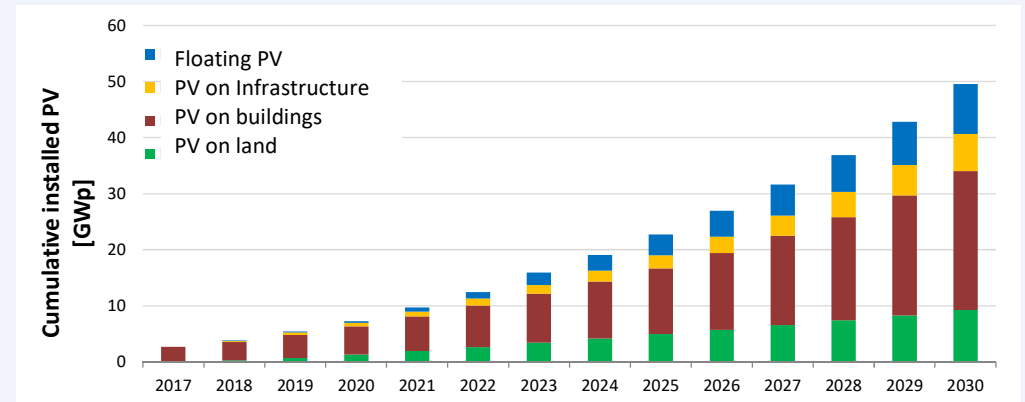
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New PV application areas

Added cost & complexity, but highest value!

- Electricity generated close to / in urban areas
 - Dual-use of space; no competition for agricultural land
 - Little or even positive effect on the environment
 - Functional and aesthetic integration
- New business opportunities (NL, EU)

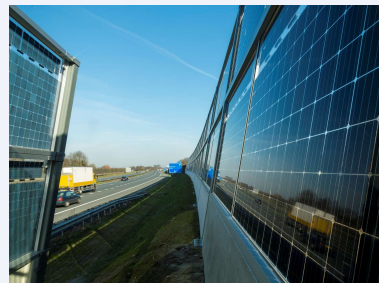
Applications Roadmap (Netherlands)



1. Land



2. Water



3. Infrastructure

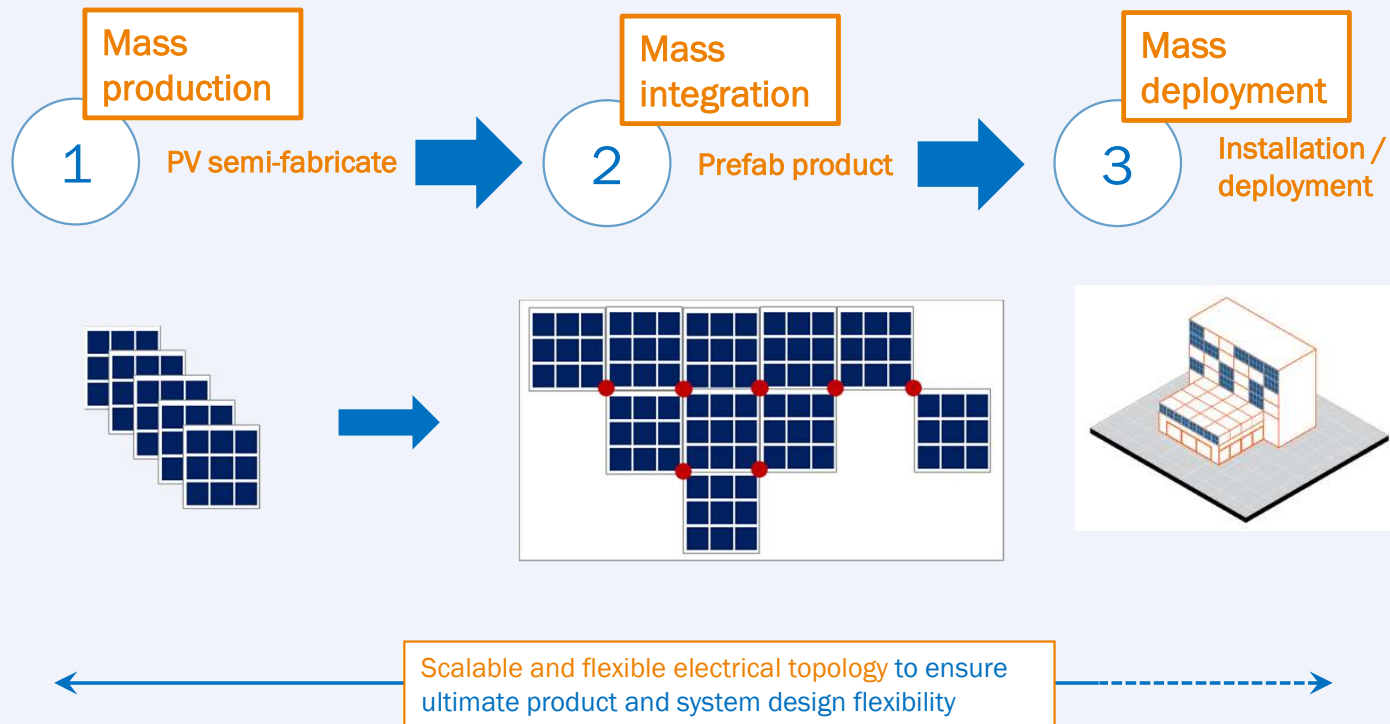


4. Buildings



5. Vehicles

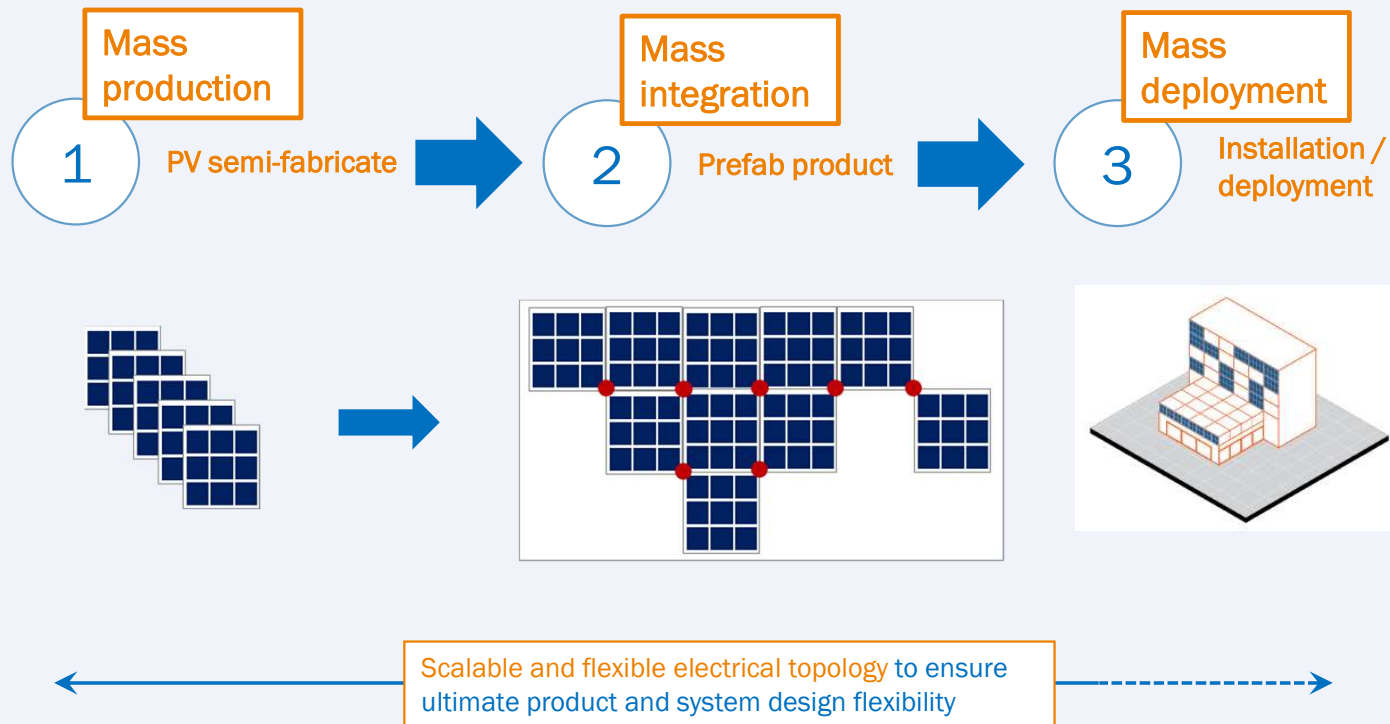
Mass customization of IPV products



Mass deployment of IPV products enabled by:

1. PV semi-fabricate produced *en masse* using state-of-the-art PV module assembly processes and materials
2. Prefab production as main route to cost reduction and quality

Mass customization of IPV products



Conductive substrate BC module technology as platform for PV integration technologies

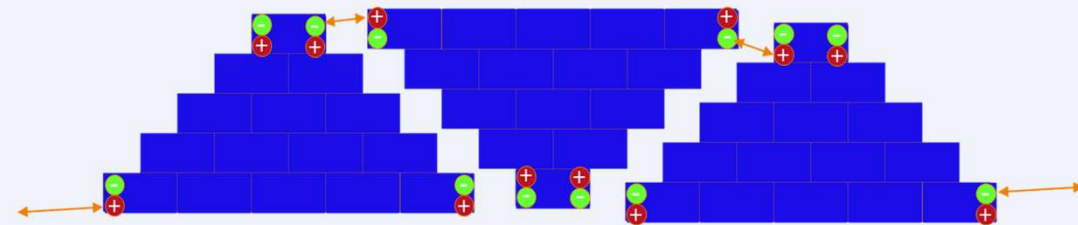
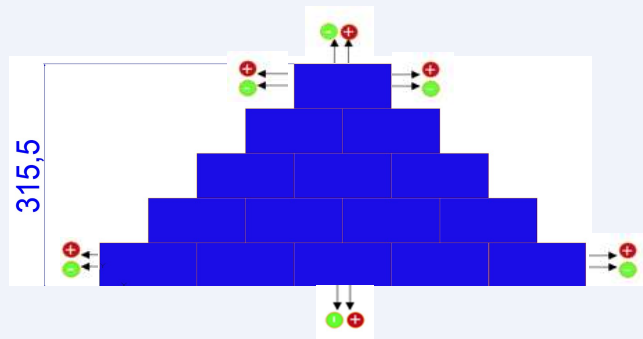
- Use of high-efficiency industrial BC cells
- Unique (electrical) design flexibility
- Highly flexible manufacturing

Outline

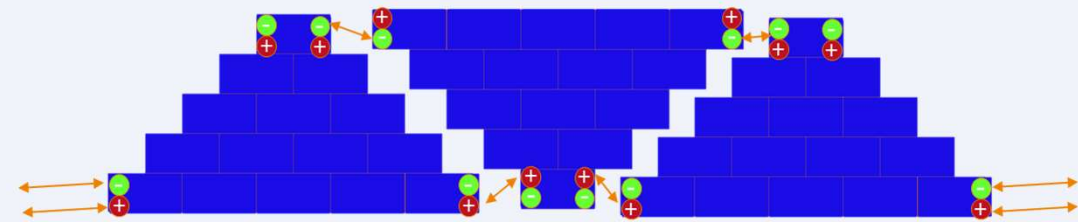
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 - Pixel module concept
 - Light-Transmitting Conductive substrate

Pixel module concept (1)

- Pixel (PV semi-fabricate) made of 15 cut cells connected in series (631×315.5 mm)
- Output terminals at every corner, along the triangle base, and rear side thanks to dedicated interconnection pattern
- Cell size, cell number, pixel size optimized to ensure desired power output
 - I_{mpp} : 3A
 - V_{mpp} : 9.3 V



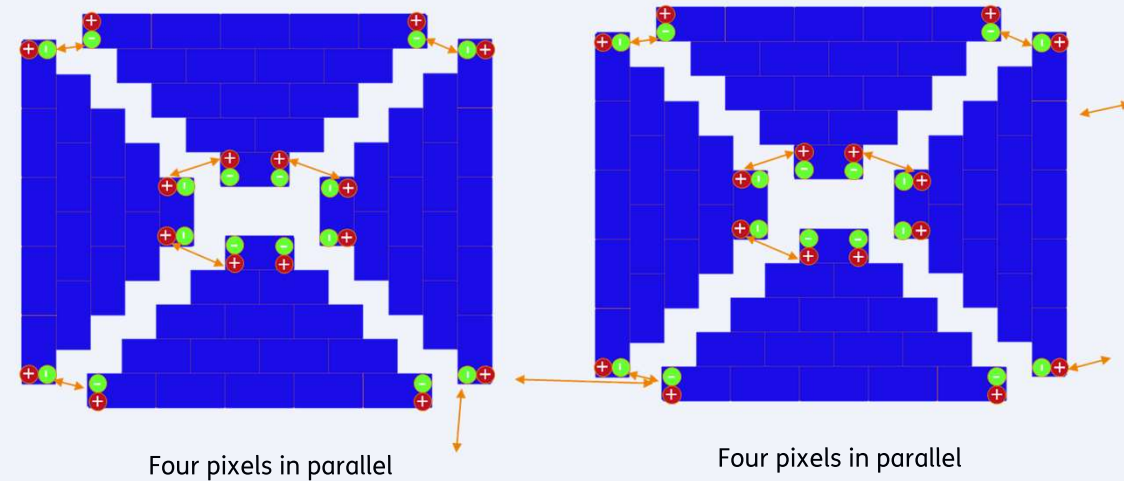
Series



Parallel

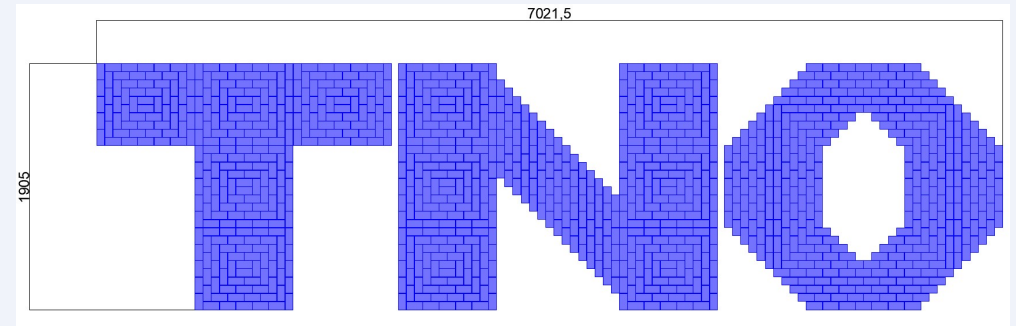
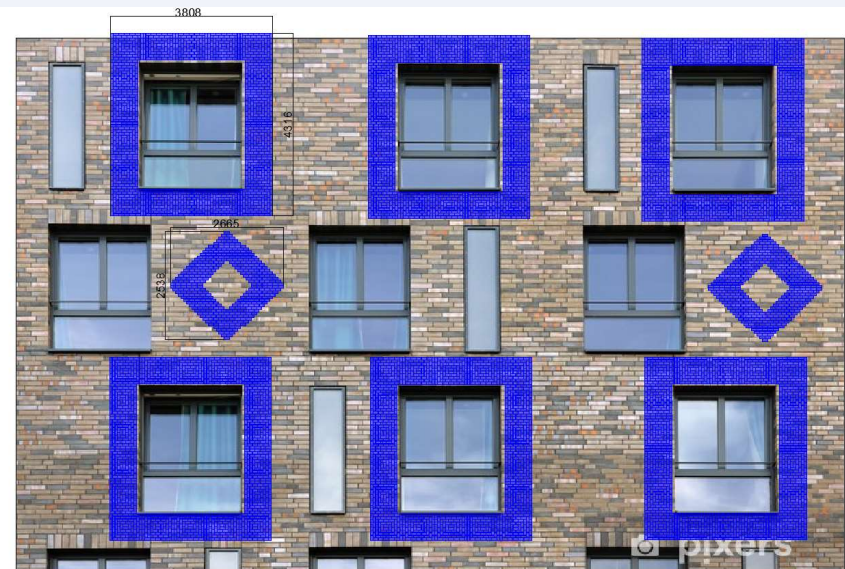
Pixel module concept (2)

- From triangular to square:
 - clusters of four pixels in parallel
 - 0.757m x 0.631m
 - V_{mpp} : 9.3V
 - I_{mpp} : 12A
- I-V characteristics of a 4-pixel cluster compatible with typical power optimiser
- Four-pixel clusters could then be connected in series to build a larger system

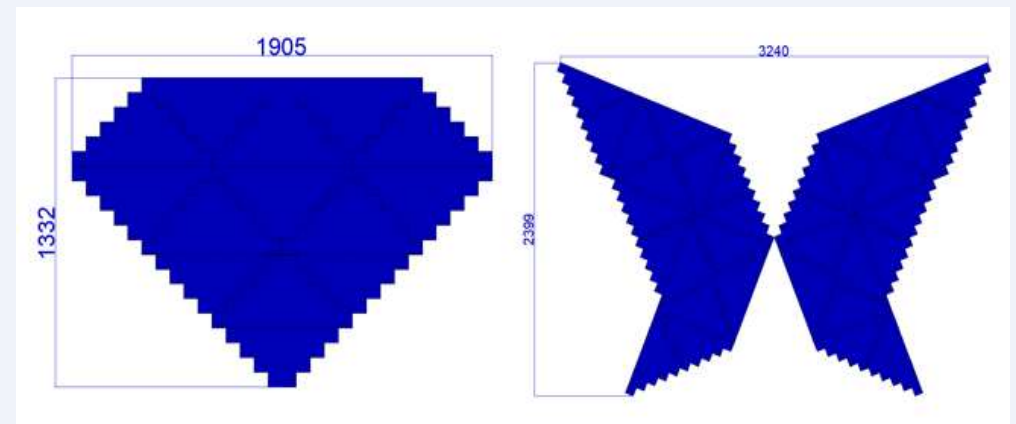


Pixel module concept (4)

- The concept is being applied for development of BIPV and VIPV products together with our industrial partners



TNO logo: x72 pixels, 9.3V, 12A

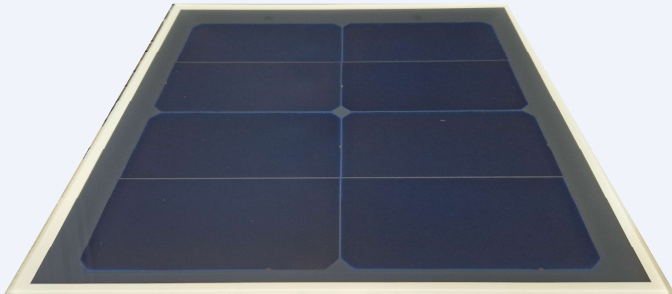
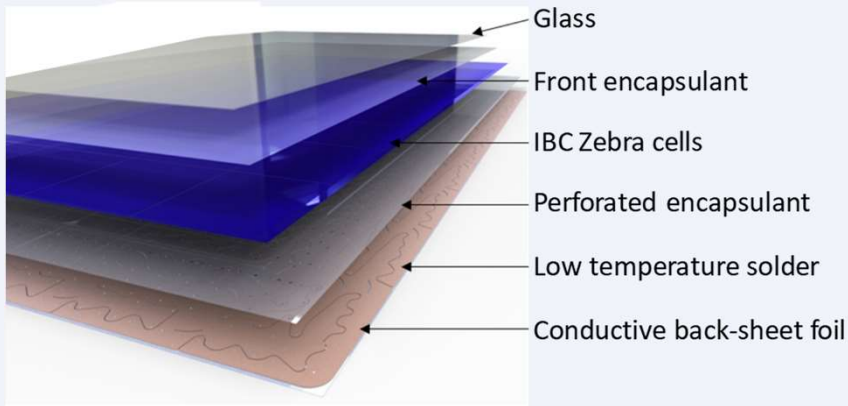


Diamond 1: x14 pixels, 65V, 6A

Butterfly: x32 pixels, 74.4V, 12A

Light-transmitting conductive substrate (1)

- TNO's mono-facial CBF-based IBC module

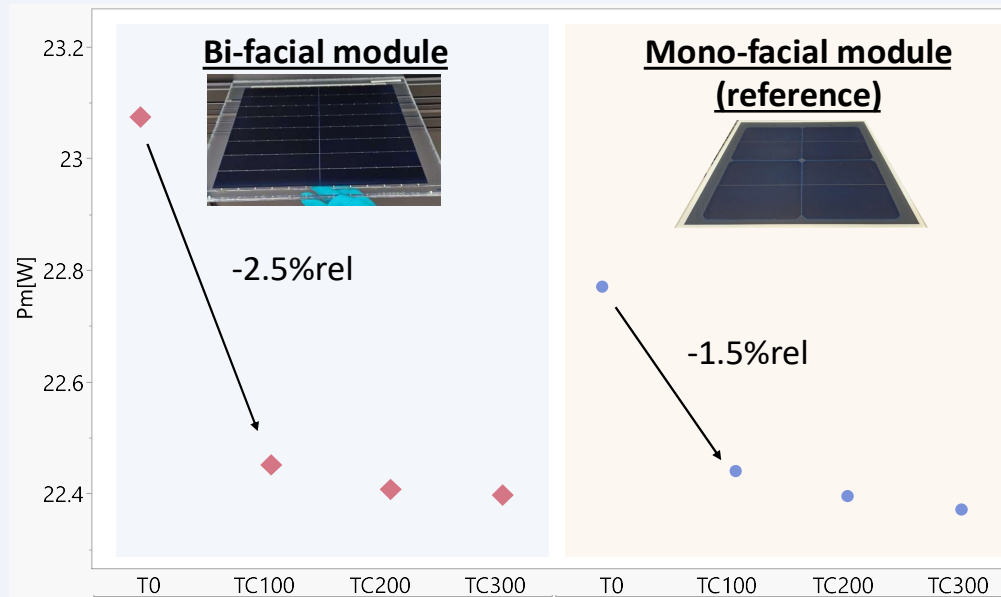


- TNO's Bi-facial module technology (under development)
 - Light Transmitting Conductive Substrate (LTCS) technology
 - Based on the standard industrial BC module assembly process (pilot line at TNO)
 - >80% bi-faciality demonstrated so far



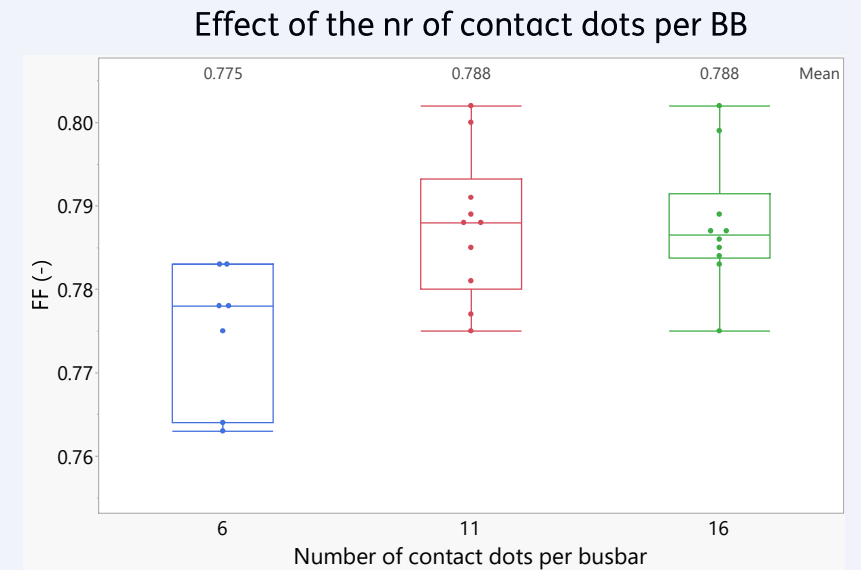
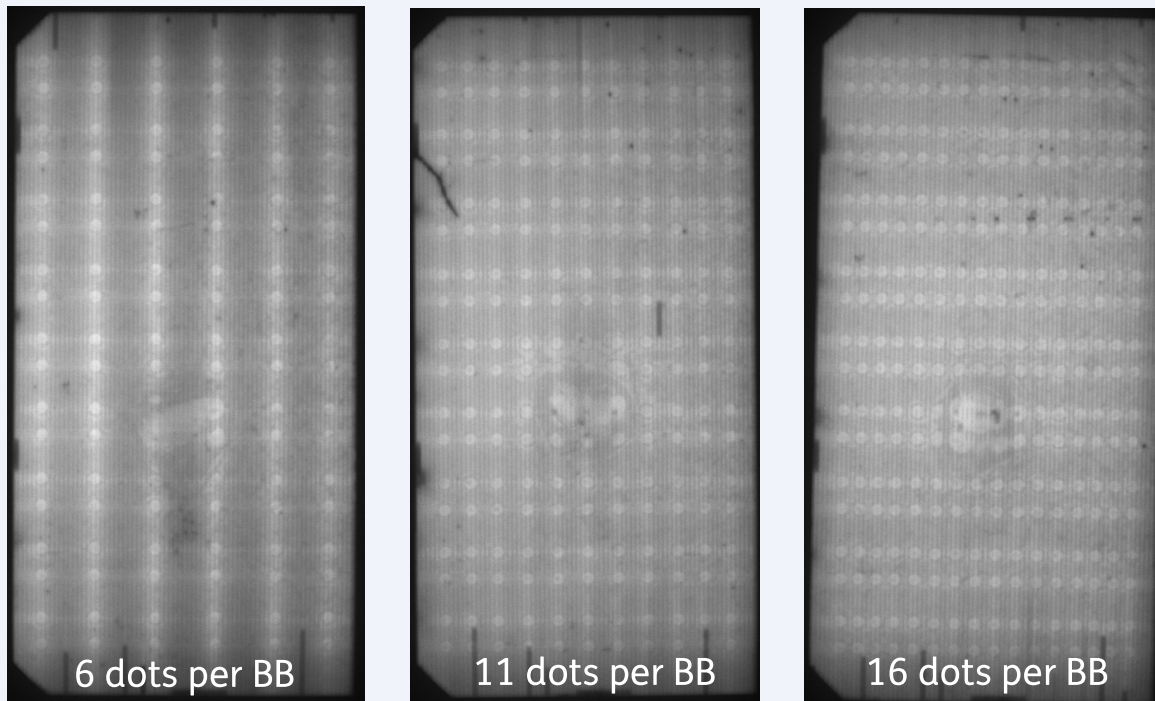
Light-transmitting conductive substrate (2)

- First 1x2m prototype built with IBC Zebra cells with >370Wp
- Good I_{sc} and V_{oc} , but suboptimal FF (process quality control)
- TC300 test passed on 40cmx40cm laminates
- Cost and performance optimisation in progress



Light-transmitting conductive substrate (3)

- Interconnection design and process optimization (IBC4EU project)

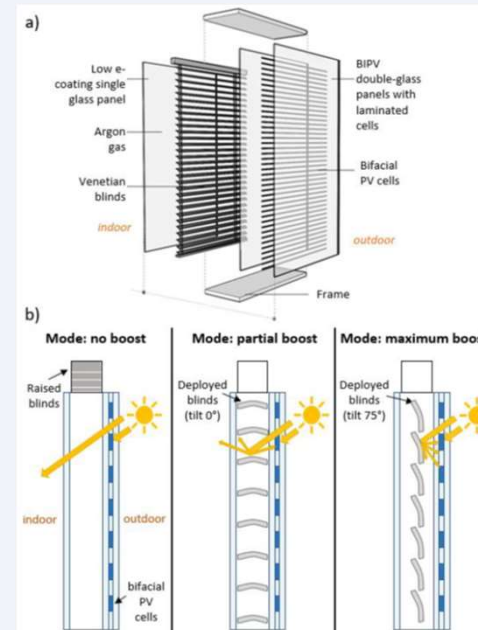
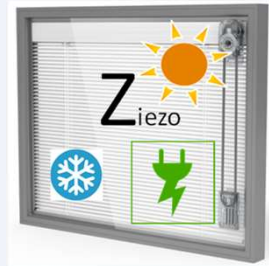


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Conductive substrate BC module technology for new applications

Light-transmitting conductive substrate (4)

- LTCS technology already implemented for BiPV application: (smart) PV windows
- Design flexibility and manufacturability demonstrated (ZIEZO project)



Outdoor Performance Analysis of Semitransparent Photovoltaic Windows with Bifacial Cells and Integrated Blinds - Villa - 2024 - Solar RRL
<https://onlinelibrary.wiley.com/doi/full/10.1002/solr.202400515>

Takeaways

- New PV application areas require advanced level of customization, both on the module and system level
- Conductive substrate back-contact module technology offers unique opportunities in terms of design freedom and manufacturability of IPV products
- TNO is committed to development of technically and economically feasible PV integration technologies together with industrial partners

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